

# YDA158

## D-4HP2

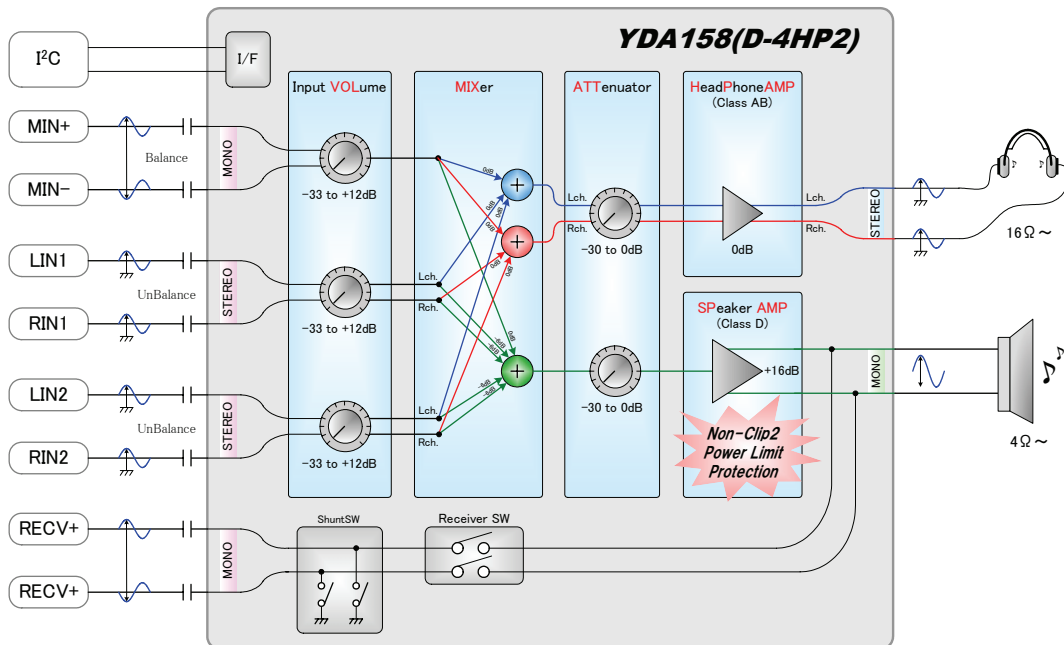
**MONAURAL 2.6W Non-Clip DIGITAL AUDIO POWER AMPLIFIER**

### ■ Outline

The YDA158 (D-4HP2) is a 2.6W ( $R_L=4\Omega$ ) $\times$ 1ch Class-D amplifier with a capless stereo headphone amplifier and receiver output. Its superior sound quality, the lowest level of distortion and noise are achieved by “Pure Pulse Direct Speaker Drive Circuit” which does not need a number of components such as a LC filter.

The YDA158 features "Non-Clip2" and “Power Limit” circuits which were developed by Yamaha. The circuits automatically detect and prevent clipping noise by shortage of supply voltage. Moreover, it is possible to set the THD level to control sound pressure.

The YDA158 has the I<sup>2</sup>C interface to control input volume, mixer, output level attenuator, power-down mode, etc. In addition, the protect function (over current, high temperature, low supply voltage malfunction), the pop noise reduction, the EMI noise reduction and the superior PSRR against TDMA (GSM) are equipped.



Schematic Diagram

## ■ Features

- Power Supply             $V_{SPVDD}$             2.7V (2.6V : min.-30°C) to 5.25V  
 $V_{AVDD}, V_{HPVDD}$     2.7V (2.6V : min.-30°C) to 3.3V
- Input                    Mono (balance) × 1,  
Stereo (unbalance) × 2
- Output                  Monaural Speaker (PWM, BTL) × 1,  
Stereo Headphone (class AB, SEPP) × 1

### Speaker Amplifier (monaural)

- Maximum Continuous Output
  - 2.6 W×1ch\*            ( $V_{SPVDD}=5.0V, R_L=4\Omega, THD+N=10\%, 25^\circ C$ )
  - 0.8 W×1ch\*            ( $V_{SPVDD}=3.6V, R_L=8\Omega, THD+N=10\%, 25^\circ C$ )
- Maximum Momentary Output
  - 2.6 W×1ch            ( $V_{SPVDD}=5.0V, R_L=4\Omega, THD+N=10\%$ )
  - 2.2 W×1ch            ( $V_{SPVDD}=5.0V, R_L=4\Omega, THD+N=1\%$ )
  - 0.8 W×1ch            ( $V_{SPVDD}=3.6V, R_L=8\Omega, THD+N=10\%$ )
  - 0.68 W×1ch           ( $V_{SPVDD}=3.6V, R_L=8\Omega, THD+N=1\%$ )
- Distortion (THD+N)   0.045 %                ( $V_{SPVDD}=3.6V, R_L=8\Omega, P_o=0.4W, 1kHz$ )
- Residual Noise        40 $\mu$ Vrms                ( $V_{SPVDD}=3.6V, \text{Mute}$ )
- S/N Ratio                90 dB                    ( $V_{SPVDD}=3.6V, V_{out}: THD+N=10\%$ )
- Efficiency                84 %                    ( $V_{SPVDD}=3.6V, R_L=8\Omega, P_o=0.8W$ )  
75 %                    ( $V_{SPVDD}=3.6V, R_L=8\Omega, P_o=0.1W$ )
- EMI Noise Reduction
- TDMA(GSM) High PSRR= -75dB            ( $V_{SPVDD} 3.6V, 217Hz$ )
- Non-Clip2                (THD ≤1%, 3%, 5%, 8%, 10%)
- Non-Clip2 Attack Time/Release Time Setting Function
- Power Limit             (0.39, 0.47, 0.60, 0.78, 0.90, 1.10W@8 $\Omega$ )
- Receiver Output Function                    (RECV/Speaker Amplifier Selectable Output)
- Overcurrent Protection Function
- High Temperature Protection Function

### Capless Headphone Amplifier (stereo)

- Maximum Continuous Output
  - 30mW×2ch            (WLCSP,  $V_{HPVDD}=3.0V, R_L=16\Omega, THD+N=1\%$ )
  - 27mW×2ch            (QFN,  $V_{HPVDD}=3.0V, R_L=16\Omega, THD+N=1\%$ )
- Distortion (THD+N)   0.03 %                ( $V_{HPVDD}=3.0V, R_L=16\Omega, P_o=5mW, 1kHz$ )
- Residual Noise        10 $\mu$ Vrms                ( $V_{HPVDD}=3.0V, \text{Mute}$ )
- S/N Ratio                92 dB                    ( $V_{HPVDD}=3.0V, R_L=16\Omega, V_{out}: THD+N=1\%$ )

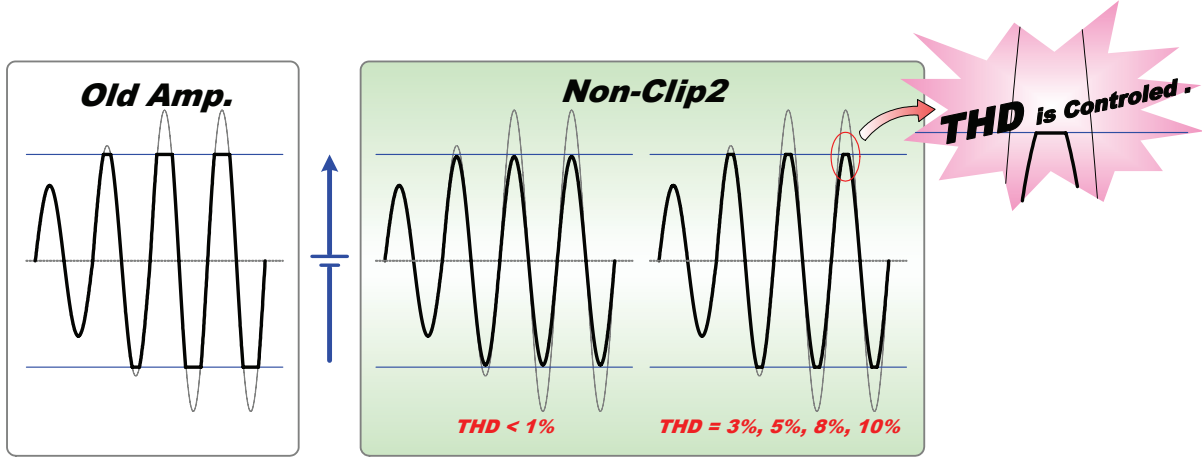
### Common

- Input Volume                                    (-33 to +12dB/1.5dB Step)
- Mixing Function
- Output Attenuator                              (-30 to 0dB/1.0dB Step)
- High-speed Startup
- Pop Noise Reduction
- Power-down Function
- I<sup>2</sup>C Control
- Low-voltage Malfunction Prevention Function
- Lead-free Package                              30 balls    WLCSP    (YDA158-PZ)  
32 pins     QFN        (YDA158-QZ)

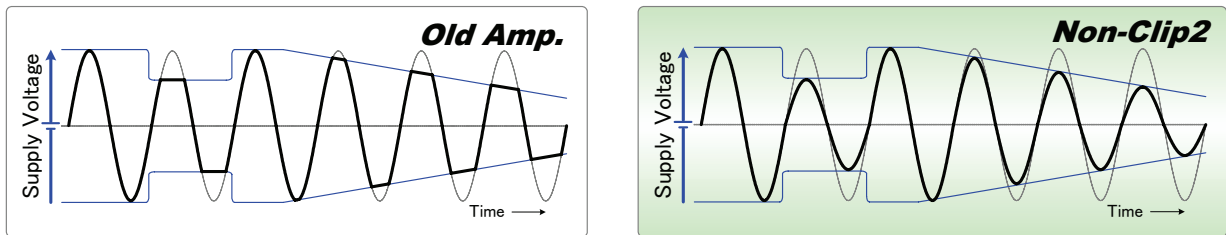
\*  $\theta_{ja}=28^\circ C/W$  (Conditions: WLCSP Evaluation Board (4 layers), no wind)

## ■ Non-Clip 2 Function

This is the function to control the speaker output clipped to a supply voltage by automatically controlling PWM amplifier gain so that it may not be distorted. Furthermore, it is also possible to set the amount of distortion such as THD=10%, etc. Since this function always follows the supply voltage, it also exerts an effect on the case in which supply voltage fluctuates such as in battery use etc.

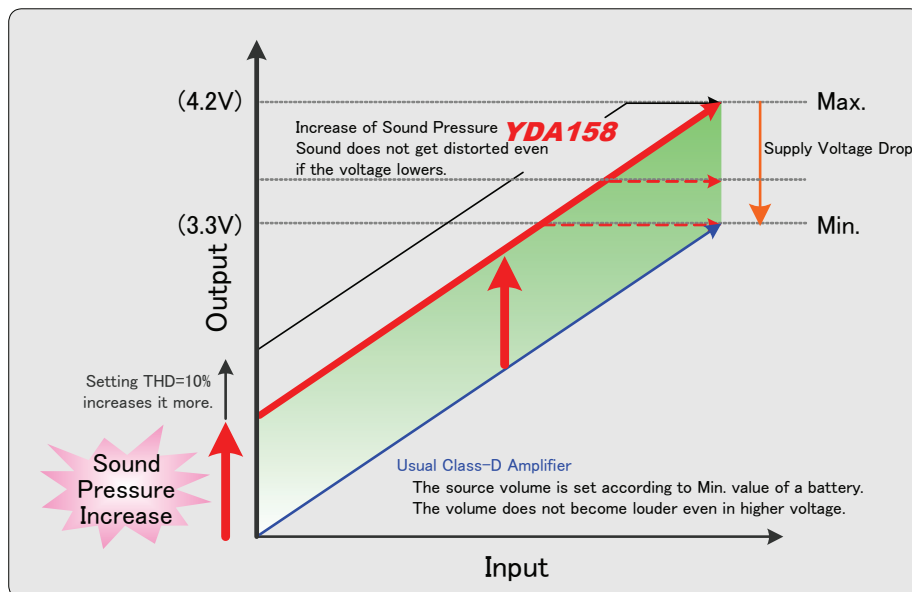


Non-Clip 2 Conceptual Diagram



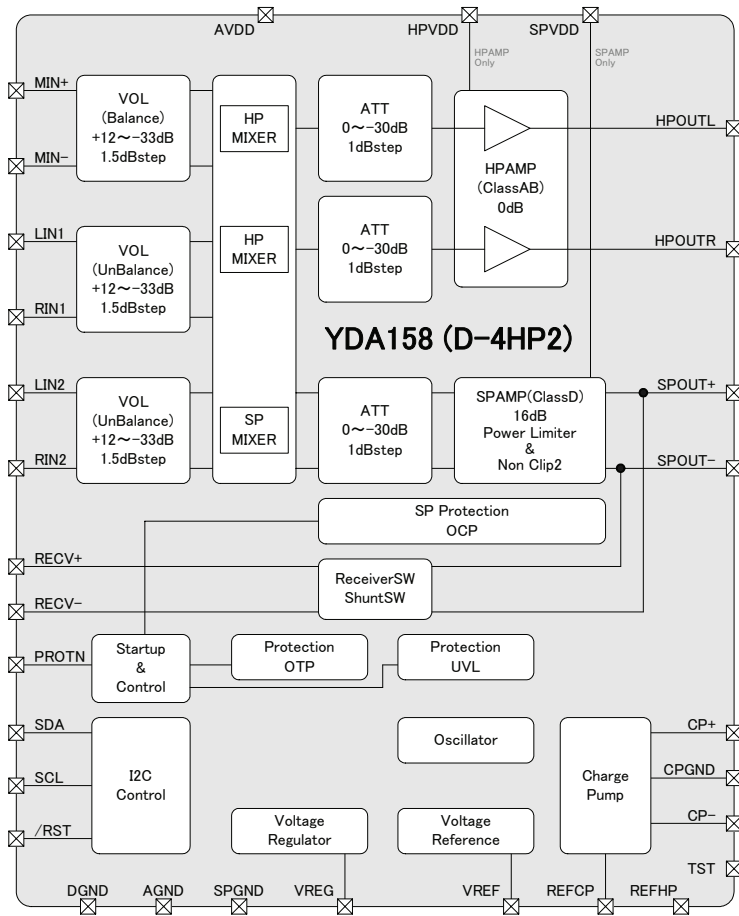
Following for the change of the supply voltage

In a conventional way, when there is a possibility of fluctuation of the supply voltage, source's volume is set so that the output does not get distorted based on the minimum voltage. But, with Non-Clip2, a source volume can be set on the basis of the maximum voltage because it always controls the volume automatically. This is an ideal function for an application that requires much sound pressure because this allows increasing the total sound pressure level.



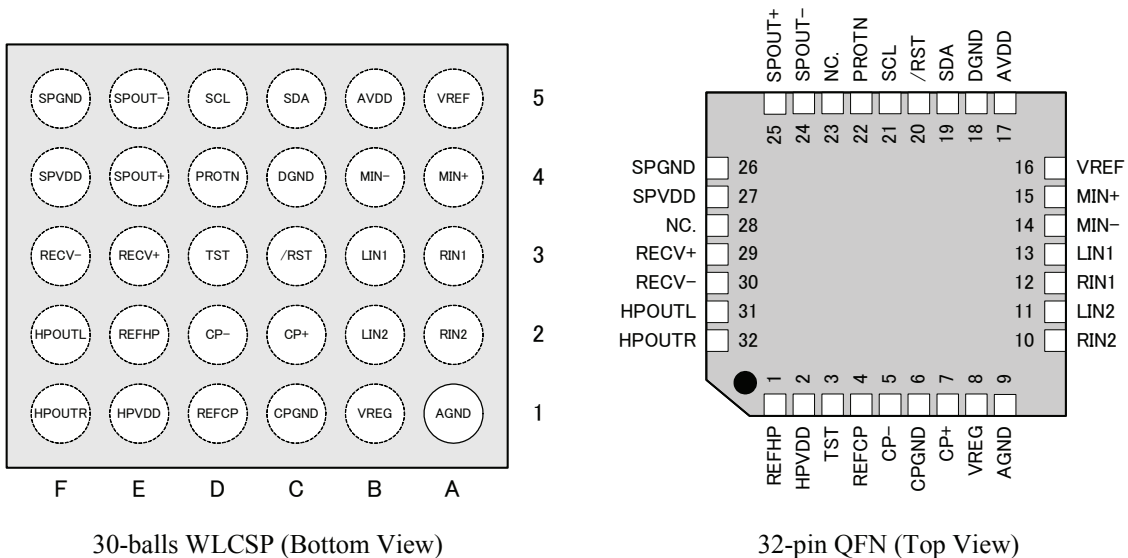
Non-Clip 2 Sound Pressure Increase

## ■ Block Diagram



Block Diagram

## ■ Pin Arrangement



30-balls WLCSP (Bottom View)

32-pin QFN (Top View)

## ■ Pin Function (WLCSP)

WLCSP Pin Function

No.	Name	I/O	Protection Circuit	Function
A1	AGND	GND	—	Ground for Analog Circuit
A2	RIN2	A	P,N	Stereo Input Pin 2 (Rch.) (*1)
A3	RIN1	A	P,N	Stereo Input Pin 1 (Rch.) (*1)
A4	MIN+	A	P,N	Monaural Differential Input Pin (positive) (*1)
A5	VREF	A	P,N	Analog Reference Power Supply Pin
B1	VREG	O	—	Reference Voltage Pin
B2	LIN2	A	P,N	Stereo Input Pin 2 (Lch.) (*1)
B3	LIN1	A	P,N	Stereo Input Pin 1 (Lch.) (*1)
B4	MIN-	A	P,N	Monaural Differential Input Pin (negative) (*1)
B5	AVDD	Power	—	Analog Power Supply
C1	CPGND	GND	—	Ground for Charge Pump
C2	CP+	O	—	Charge Pump pin (positive)
C3	/RST	IS	N	Reset Pin, "L": Reset
C4	DGND	GND	—	Digital Ground
C5	SDA	IOD	N	I <sup>2</sup> C Serial Data Pin
D1	REFCP	O	—	Charge Pump Output Pin
D2	CP-	O	—	Charge Pump pin (negative)
D3	TST	IS	N	Test setting Pin (Ground Connection)
D4	PROTN	OD	—	Error Output Pin (overcurrent, high temperature)
D5	SCL	IS	N	I <sup>2</sup> C Serial Clock Pin
E1	HPVDD	Power	—	Power Supply for Headphone Amplifier
E2	REFHP	A	N	Minus Reference Voltage Pin for Headphone Amplifier
E3	RECV+	A	N	Receiver Signal Input Pin (positive) (*2)
E4	SPOUT+	O	—	Speaker Amplifier Output Pin (positive)
E5	SPOUT-	O	—	Speaker Amplifier Output Pin (negative)
F1	HPOUTR	O	—	Headphone Amplifier Output Pin (Rch.)
F2	HPOUTL	O	—	Headphone Amplifier Output Pin (Lch.)
F3	RECV-	A	N	Receiver Signal Input Pin (negative) (*2)
F4	SPVDD	Power	—	Power Supply for Speaker Amplifier Output
F5	SPGND	GND	—	Ground for Speaker Amplifier Output

A: Analog Pin, IS: Schmitt Trigger Input Pin, O: Output Pin, OD: Open-drain Pin, IOD: I/O Pin (Open-drain Output)

- \* 1. Note that leakage current flows through the protection circuit (PMOS Tr.) when applying a voltage higher than AVDD to this pin.
- \* 2. Note that leakage current flows when applying a voltage higher than SPVDD to this pin.

**■ Pin Function (QFN)**

## QFN Pin Function

No.	Name	I/O	Protection Circuit	Function
1	REFHP	A	N	Minus Reference Voltage Pin for Headphone Amplifier
2	HPVDD	Power	—	Power Supply for Headphone Amplifier
3	TST	IS	N	Test setting Pin (Ground Connection)
4	REFCP	O	—	Charge Pump Output Pin
5	CP-	O	—	Charge Pump pin (negative)
6	CPGND	GND	—	Ground for Charge Pump
7	CP+	O	—	Charge Pump pin (positive)
8	VREG	O	—	Reference Voltage Pin
9	AGND	GND	—	Ground for Analog Circuit
10	RIN2	A	P,N	Stereo Input Pin 2 (Rch.) (*1)
11	LIN2	A	P,N	Stereo Input Pin 2 (Lch.) (*1)
12	RIN1	A	P,N	Stereo Input Pin 1 (Rch.) (*1)
13	LIN1	A	P,N	Stereo Input Pin 1 (Lch.) (*1)
14	MIN-	A	P,N	Monaural Differential Input Pin (negative) (*1)
15	MIN+	A	P,N	Monaural Differential Input Pin (positive) (*1)
16	VREF	A	P,N	Analog Reference Power Supply Pin
17	AVDD	Power	—	Analog Power Supply
18	DGND	GND	—	Digital Ground
19	SDA	IOD	N	I <sup>2</sup> C Serial Data Pin
20	/RST	IS	N	Reset Pin, "L": Reset
21	SCL	IS	N	I <sup>2</sup> C Serial Clock Pin
22	PROTN	OD	—	Error Output Pin (overcurrent, high temperature)
23	NC.	—	—	—
24	SPOUT-	O	—	Speaker Amplifier Output Pin (negative)
25	SPOUT+	O	—	Speaker Amplifier Output Pin (positive)
26	SPGND	GND	—	Ground for Speaker Amplifier Output
27	SPVDD	Power	—	Power Supply for Speaker Amplifier Output
28	NC.	—	—	—
29	RECV+	A	N	Receiver Signal Input Pin (positive) (*2)
30	RECV-	A	N	Receiver Signal Input Pin (negative) (*2)
31	HPOUTL	O	—	Headphone Amplifier Output Pin (Lch.)
32	HPOUTR	O	—	Headphone Amplifier Output Pin (Rch.)

A: Analog Pin, IS: Schmitt Trigger Input Pin, O: Output Pin, OD: Open-drain Pin, IOD: I/O Pin (Open-drain Output)

\* 1. Note that leakage current flows through the protection circuit (PMOS Tr.) when applying a voltage higher than AVDD to this pin.

\* 2. Note that leakage current flows when applying a voltage higher than SPVDD to this pin.

## ■ Electrical Characteristics

### Absolute Maximum Ratings See Note.)

Item	Symbol	Min.	Max.	Unit
SPVDD pin Voltage Range	V <sub>SPVDD</sub>	-0.3	6.0	V
AVDD pin Voltage Range	V <sub>AVDD</sub>	-0.3	4.2	V
HPVDD pin Voltage Range	V <sub>HPVDD</sub>	-0.3	4.2	V
Input pin Voltage Range (Analog input pins) *1	V <sub>INA</sub>	V <sub>AGND</sub> -0.6	V <sub>AVDD</sub> +0.6	V
Input pin Voltage Range (RECV+,RECV- pins)	V <sub>INR</sub>	V <sub>SPGND</sub> -0.3	V <sub>SPVDD</sub> +0.3	V
Input pin Voltage Range (input pins other than the above)	V <sub>IN</sub>	V <sub>AGND</sub> -0.3	V <sub>AVDD</sub> +0.3	V
Power Dissipation (WLCSP30,Ta=25°C) *2	P <sub>D25</sub>	-	3.54	W
Power Dissipation (WLCSP30,Ta=70°C) *2	P <sub>D70</sub>		1.95	
Power Dissipation (WLCSP30,Ta=85°C) *2	P <sub>D85</sub>		1.42	
Power Dissipation (QFN32,Ta=25°C) *3	P <sub>D25</sub>	-	3.75	W
Power Dissipation (QFN32,Ta=70°C) *3	P <sub>D70</sub>		2.06	
Power Dissipation (QFN32,Ta=85°C) *3	P <sub>D85</sub>		1.50	
Junction Temperature	T <sub>jmax</sub>	-	125	°C
Storage Temperature	T <sub>STG</sub>	-50	125	°C
Speaker Impedance	R <sub>LS</sub>	3.2	-	Ω
Headphone Speaker Impedance	R <sub>HLS</sub>	12.8	-	Ω

Note) Absolute Maximum Ratings are values which must not be exceeded to guarantee device reliability and life, and when using a device in excess of the ratings for even a moment, it may immediately cause damage to the device or may significantly deteriorate its reliability. In the system where the voltage at an input pin may exceed the supply voltage (V<sub>AVDD</sub>/GND), use an external diode etc. to limit it to the value lower than absolute maximum rating.

\* SPGND=AGND=DGND=CPGND=0V

\*1: MIN+, MIN-, LIN1, RIN1, LIN2, and RIN2 pins

\*2: θ<sub>ja</sub>=28 °C/W Condition: Evaluation Board (4 layers), No wind

\*3: θ<sub>ja</sub>=27 °C/W Condition: Evaluation Board (4 layers), No wind

### Recommended Operating Conditions

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
SPVDD Supply Voltage	V <sub>SPVDD</sub>	T <sub>A</sub> (Min.) = -40 °C	2.7	3.6	5.25	V
		T <sub>A</sub> (Min.) = -30 °C	2.6			
AVDD Supply Voltage	V <sub>AVDD</sub>	T <sub>A</sub> (Min.) = -40 °C	2.7	3.0	3.3	V
		T <sub>A</sub> (Min.) = -30 °C	2.6			
HPVDD Supply Voltage	V <sub>HPVDD</sub>	T <sub>A</sub> (Min.) = -40 °C	2.7	3.0	3.3	V
		T <sub>A</sub> (Min.) = -30 °C	2.6			
Operating Ambient Temperature	T <sub>A</sub>		-40	25	85	°C

\* Use the device within the recommended operating conditions.

\* SPGND=AGND=DGND=CPGND=0V

\* **SPVDD ≥ AVDD=HPVDD**

\* Power up SPVDD and AVDD=HPVDD in this order.

\* The slew rate of SPVDD, AVDD, and HPVDD should be less than 1V/μsec.

\* When in use, pay attention so that supply voltages do not lower than the shutdown threshold voltage.

## Consumption Current

(SPVDD=3.6V, AVDD=HPVDD=3.0V, SPGND=AGND=DGND=CPGND=0V, TA=25°C, unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Speaker Mode						
SPVDD Consumption Current	$I_{SPVDD}$	No load, No input PD_HP="1"	-	1.5	-	mA
AVDD, HPVDD Consumption Current	$I_{VDD}$		-	3.5	-	mA
Headphone Mode						
SPVDD Consumption Current	$I_{SPVDD}$	No load, No input PD_SP="1"	-	1.0	-	$\mu$ A
AVDD, HPVDD Consumption Current	$I_{VDD}$		-	8.0	-	mA
Receiver Mode						
SPVDD Consumption Current	$I_{SPVDD}$	No load, No input PDPC="0", PD_REC="0" Another is Register Default.	-	30	-	$\mu$ A
AVDD, HPVDD Consumption Current	$I_{VDD}$		-	1.2	-	mA
Power-down Mode Consumption Current	$I_{PD}$	Register Default	-	1.0	-	$\mu$ A

## DC Characteristics

(SPVDD=2.7 to 5.25V, AVDD=HPVDD=2.7 to 3.3V, SPGND=AGND=DGND=CPGND=0V, TA=-40°C to 85°C, unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
AVDD Startup Threshold Voltage	$V_{UVLH}$		-	2.2	-	V
AVDD Shutdown Threshold Voltage	$V_{UVLL}$		-	2.0	-	V
Digital Input Voltage H Level	$V_{IH}$	SDA, SCL, /RST	1.4	-	-	V
Digital Input Voltage L Level	$V_{IL}$	SDA, SCL, /RST	-	-	0.4	V
I <sup>2</sup> C Output Voltage	$V_{OL}$	$I_{OL}=3mA$ SDA	-	-	0.4	V
Input Capacitance	CI	SDA, SCL, /RST	-	-	10	pF
Schmitt Width	$V_{sh}$	SDA, SCL, /RST	-	200	-	mV
PROTN L Level Output Voltage	$V_{OLPROTN}$	$I_{OL}=400\mu A$	-	-	0.4	V
VREF pin Voltage	$V_{ref}$		-	$V_{AVDD}/2$	-	V



## AC Characteristics

(SPVDD=2.7 to 5.25V, AVDD=HPVDD=2.7 to 3.3V, SPGND=AGND=DGND=CPGND=0V, TA=-40°C to 85°C, unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Input DC-cut Capacitor Charge Time	$T_{CHG}$	DC-cut capacitor 0.1 $\mu$ F	-	15	23	msec
Headphone Amplifier Startup Time	$T_{STUP2}$		-	4	8	msec
Input Resistance	$R_{IN}$		15	-	180	k $\Omega$
Input Resistance at power down	$R_{INPD}$	LIN1, RIN1, LIN2, RIN2 pins	-	12	-	k $\Omega$
		MIN+, MIN- pins		6		
Attack Time 0	$T_{AT0}$	DATT[1:0]=00	-	0.12	-	msec/dB
Attack Time 1	$T_{AT1}$	DATT[1:0]=01		1.2		
Attack Time 2	$T_{AT2}$	DATT[1:0]=10		2.4		
Attack Time 3	$T_{AT3}$	DATT[1:0]=11		5.4		
Release Time 0	$T_{RL0}$	DREL[1:0]=00	-	0.02	-	sec/dB
Release Time 1	$T_{RL1}$	DREL[1:0]=01		0.06		
Release Time 2	$T_{RL2}$	DREL[1:0]=10		0.12		
Release Time 3	$T_{RL3}$	DREL[1:0]=11		0.30		
Carrier Clock Frequency	$F_{PWM}$		-	470	-	kHz
PROTN Drive Load Capacitance	$C_{PROTN}$		-	-	160	pF

## Analog Characteristics

### Speaker Amplifier

(SPVDD=3.6V, AVDD=HPVDD=3.0V, SPGND=AGND=DGND=CPGND=0V, 1kHz, TA=25°C, VOL=ATT=0dB, unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	
Maximum Output	P <sub>O</sub>	SPVDD=5V, R <sub>L</sub> =4Ω, THD+N=10%	-	2.6	-	W	
		SPVDD=5V, R <sub>L</sub> =4Ω, THD+N=1%		2.2			
		R <sub>L</sub> =8Ω THD+N=10%		0.8			
		R <sub>L</sub> =8Ω THD+N=1%		0.68			
Maximum Output in Non-clip control	P <sub>ONC1</sub>	SPVDD=5V, R <sub>L</sub> =4Ω, DALC[2:0]=001	-	1.7	-	W	
		R <sub>L</sub> =8Ω, DALC[2:0]=001		0.55			
	P <sub>ONC2</sub>	SPVDD=5V, R <sub>L</sub> =4Ω, DALC[2:0]=100	-	2.3	-	W	
		R <sub>L</sub> =8Ω, DALC[2:0]=100		0.73			
	P <sub>ONC3</sub>	SPVDD=5V, R <sub>L</sub> =4Ω, DALC[2:0]=101	-	2.4	-	W	
		R <sub>L</sub> =8Ω, DALC[2:0]=101		0.75			
	P <sub>ONC4</sub>	SPVDD=5V, R <sub>L</sub> =4Ω, DALC[2:0]=110	-	2.5	-	W	
		R <sub>L</sub> =8Ω, DALC[2:0]=110		0.78			
	P <sub>ONC5</sub>	SPVDD=5V, R <sub>L</sub> =4Ω, DALC[2:0]=111	-	2.6	-	W	
		R <sub>L</sub> =8Ω, DALC[2:0]=111		0.8			
	Total Harmonic Distortion (BW:20kHz)	THD+N	R <sub>L</sub> =4Ω, P <sub>O</sub> =0.65W	-	0.045	-	%
			R <sub>L</sub> =8Ω, P <sub>O</sub> =0.4W		0.045		
Noise(BW:20kHz A-Filter)	N	MUTE (See Note 2.)	-	40	-	μVrms	
S/N Ratio (BW:20kHz A-Filter)	SNR	Monaural differential input	-	90	-	dB	
		Stereo input	-	92	-	dB	
PSRR	PSRR	217Hz(SPVDD)	-	-75	-	dB	
Efficiency	η	R <sub>L</sub> =8Ω, P <sub>O</sub> =0.8W	-	84	-	%	
		R <sub>L</sub> =8Ω, P <sub>O</sub> =0.1W	-	75	-	%	
Output Offset Voltage	V <sub>O</sub>	MUTE (See Note 2.)	-	±20	-	mV	
Frequency Characteristics (Cin=0.1uF)	Fres	100Hz to 20kHz	-3	-	4	dB	
Non-Clip2 Maximum Attenuation Gain	Aa		-	-8.4	-	dB	
Power Limit Output Power (THD+N=10%)	P <sub>PL1</sub>	R <sub>L</sub> =8Ω, DPLT[2:0]=001	-	390	-	mW	
	P <sub>PL2</sub>	R <sub>L</sub> =8Ω, DPLT[2:0]=010		470			
	P <sub>PL3</sub>	R <sub>L</sub> =8Ω, DPLT[2:0]=011		600			
	P <sub>PL4</sub>	R <sub>L</sub> =8Ω, DPLT[2:0]=100		780			
	P <sub>PL5</sub>	R <sub>L</sub> =8Ω, DPLT[2:0]=101		900			
	P <sub>PL6</sub>	R <sub>L</sub> =8Ω, DPLT[2:0]=110, SPVDD=4V		1100			

Note1: All analog characteristics were obtained by using our evaluation board. Depending upon pattern layout etc., characteristics may vary.  
The measurement condition "RL=8Ω" is actually a pure resistor of 8Ω plus 30μH (8Ω+30μH).

Note2: Volume = Mixer = Attenuator = MUTE

## Headphone Amplifier

(SPVDD=3.6, AVDD=HPVDD=3.0V, SPGND=AGND=DGND=CPGND=0V, 1kHz, TA=25°C, VOL=ATT=0dB, unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Maximum Output	P <sub>o</sub>	WLCSP, R <sub>L</sub> =16Ω, THD+N=1%	-	30	-	mW
		QFN, R <sub>L</sub> =16Ω, THD+N=1%		27		
Total Harmonic Distortion (BW:20kHz)	THD+N	R <sub>L</sub> =16Ω, P <sub>o</sub> =5mW	-	0.03	-	%
Noise (BW:20kHz A-Filter)	N	MUTE (See Note2.)	-	10	-	μVrms
S/N Ratio (BW:20kHz A-Filter)	SNR		-	92	-	dB
Output Offset Voltage	V <sub>o</sub>	MUTE (See Note2.)	-	±2	-	mV
Frequency Characteristics (C <sub>in</sub> =0.1μF)	Fres	100Hz to 20kHz	-3	-	1	dB
Channel Separation	CS	R <sub>L</sub> =16Ω	-	90	-	dB

Note1: All analog characteristics were obtained by using our evaluation board. Depending upon pattern layout etc., characteristics may vary.

Note2: Volume = Mixer = Attenuator = MUTE

## Receiver Switch

(SPVDD=3.6, AVDD=HPVDD=3.0V, SPGND=AGND=DGND=CPGND=0V, TA=25°C, unless otherwise specified)

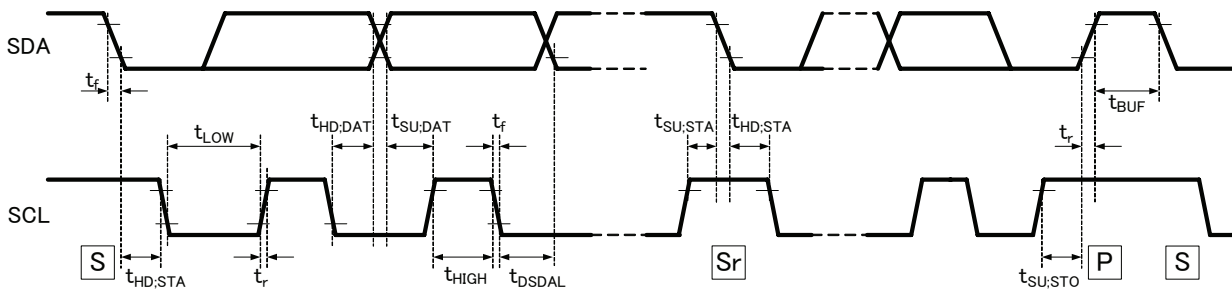
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Resistance at Receiver SW ON	R <sub>on</sub>		-	1.5	-	Ω

Note1: All analog characteristics were obtained by using our evaluation board. Depending upon pattern layout etc., characteristics may vary.

## I<sup>2</sup>C Timing

(SPVDD=2.7 to 5.25V, AVDD=HPVDD=2.7 to 3.3V, SPGND=AGND=DGND=CPGND=0V, TA=-40°C to 85°C, unless otherwise specified)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>Input Conditions</b>						
SCL Input Clock Frequency	f <sub>SCL</sub>		0	-	400	kHz
“START” Condition Hold Time	t <sub>HD;STA</sub>		0.6	-	-	ns
SCL Input Clock “L” Time	t <sub>LOW</sub>		1.3	-	-	ns
SCL Input Clock “H” Time	t <sub>HIGH</sub>		0.6	-	-	ns
Repeat “START” Condition Setup Time	t <sub>SU;STA</sub>		0.6	-	-	ns
Data Input Hold Time	t <sub>HD;DAT</sub>		0	-	-	ns
Data Input Setup Time	t <sub>SU;DAT</sub>		100	-	-	ns
SDA,SCL Input Rise Time	t <sub>r</sub>		-	-	300	ns
SDA,SCL Input Fall Time	t <sub>f</sub>		-	-	300	ns
“STOP” Condition Setup Time	t <sub>SU;STO</sub>		0.6	-	-	ns
Bus Free Time between “STOP” and “START” conditions	t <sub>BUF</sub>		1.3	-	-	ns
Capacitance Load of each bus line	C <sub>b</sub>		-	-	400	pF
<b>Output Conditions</b>						
SDA “L” Output Delay Time	t <sub>DSDAL</sub>		-	-	1.15	μs
Data Output Hold Time	t <sub>HD;DAT</sub>		0	-	0.9	μs

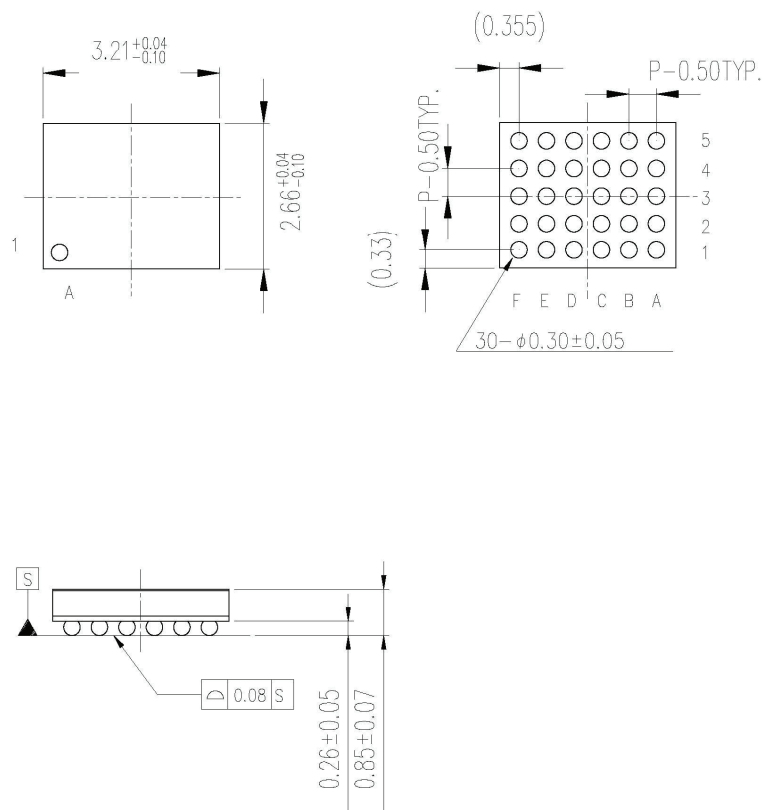


“S”: Start Condition, “Sr”: Repetitive Start Condition, “P”: Stop Condition

\* The measurement was performed at the following conditions:  
 Input Conditions : V<sub>IH</sub>=0.8×AVDD, V<sub>IL</sub>=0.1×AVDD  
 Measurement Points: V<sub>OH</sub>=0.7×AVDD, V<sub>OL</sub>=0.3×AVDD

## ■ Package Outline (WLCSP)

C-PK30PP-1



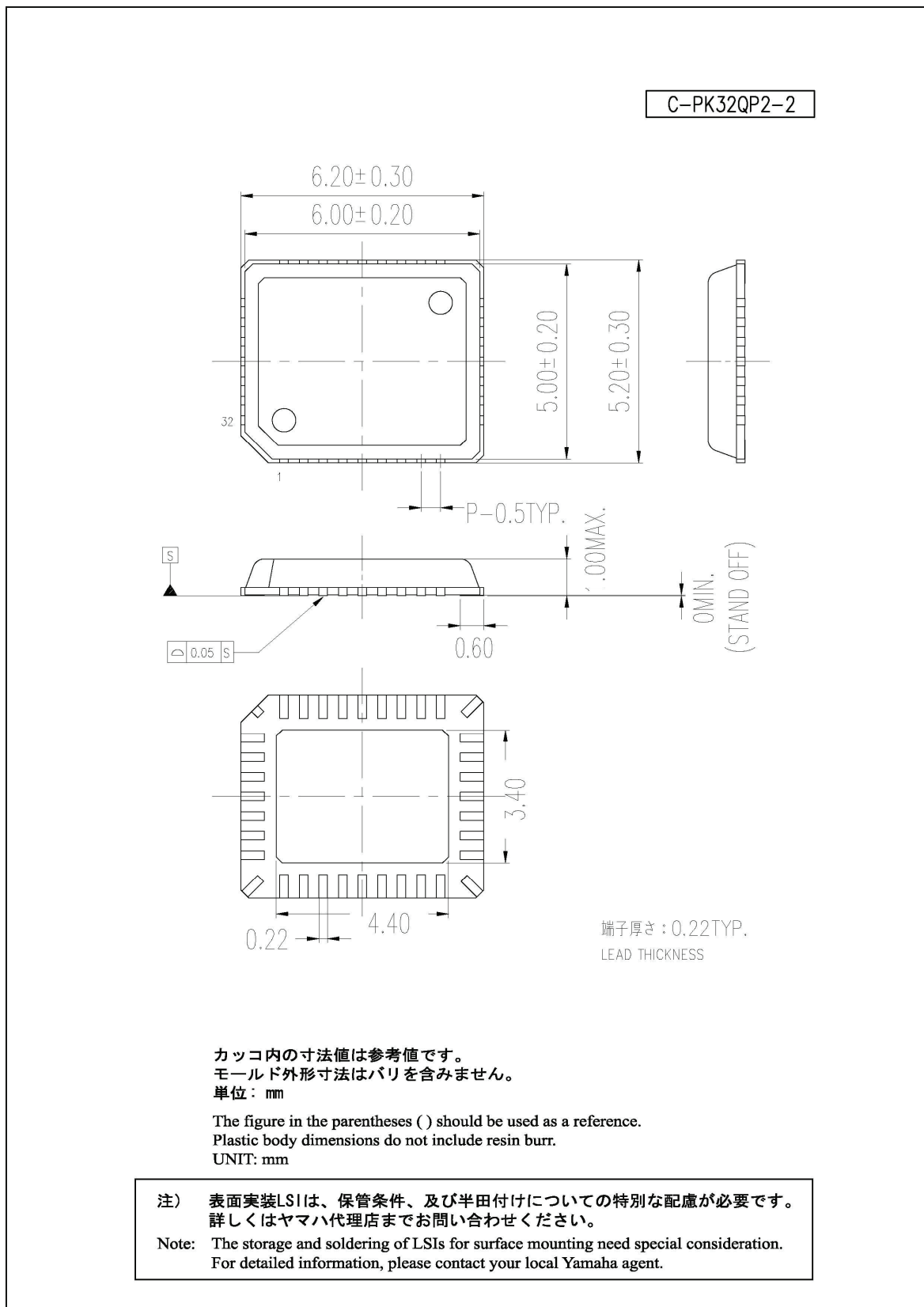
カッコ内の寸法値は参考値です。  
外形寸法はバリを含みます。

単位: mm  
The figure in the parentheses ( ) should be used as a reference.  
The dimensions include burr.  
UNIT: mm

注) 表面実装LSIは、保管条件、及び半田付けについての特別な配慮が必要です。  
詳しくはヤマハ代理店までお問い合わせください。

Note: The storage and soldering of LSI's for surface mounting need special consideration.  
For detailed information, please contact your local Yamaha agent.

■ Package Outline (QFN)



MEMO

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AGENT

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